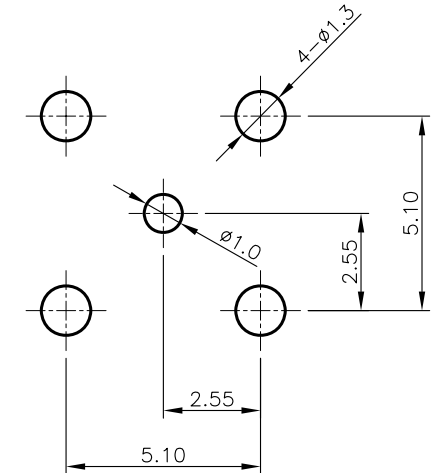
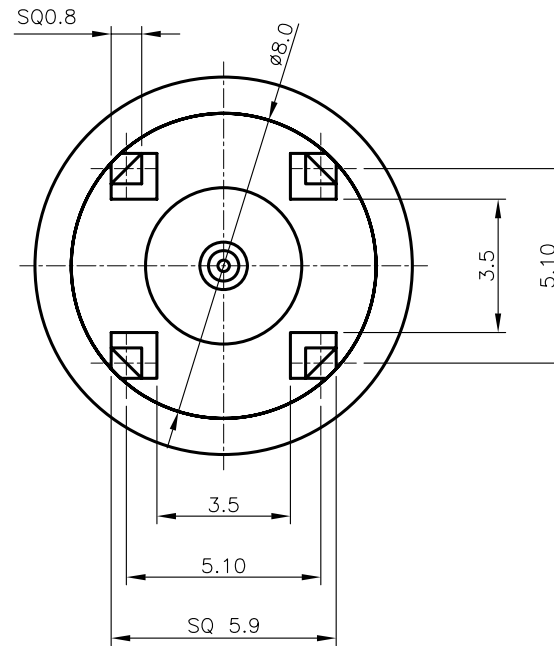
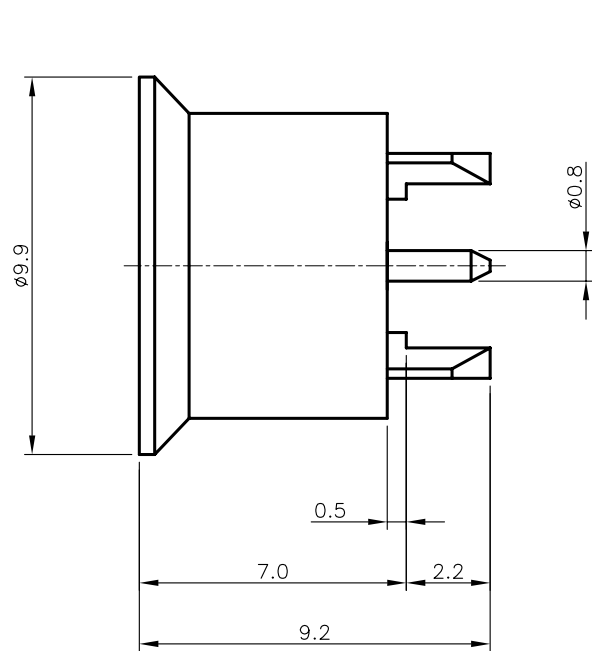
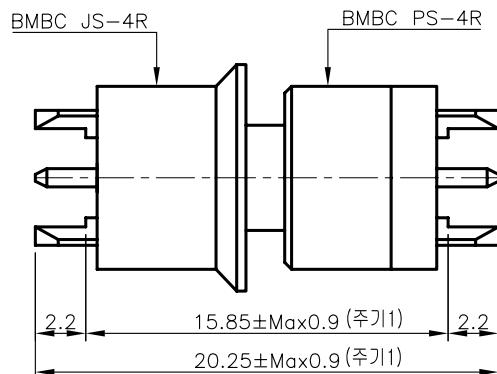


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	I.C.KIM		2017.01.09.
1	BMBC 공용화 치수 적용	S.Y.EUN	I.C.KIM	2018.11.27.
2	완제품 관리 코드 변경	S.Y.EUN	I.C.KIM	2020.02.04.



PCB MOUNTING HOLE SIZE

* MATING 후 치수 (SCALE 3:1)



주 기

1. Axial Working Range : Max±0.9mm
→ PCB to PCB 범위 : 14.95mm ~ 16.75mm
→ 전장치수범위 : 19.35mm ~ 21.15mm

※ Max 0.9mm 이상 벗어날 경우
접촉 신호불량 문제 발생될 수 있음

3	INSULATOR	1	TEFLON		DIN02870-N/2
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT03804-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04279-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE	2018. 11. 27.
	Angle	APPROVED BY	I.C.KIM
MATERIAL		CHECKED BY	
		DRAWN BY	S.Y.EUN
FINISH		SCALE	5/1
		UNIT	mm



RF & MICROWAVE
TECHNOLOGY
Tel : 82-32-347-8015
Fax : 82-32-347-8017

TITLE				BMBC50 PCB JS-4R	
A4	DWG NO.	CN03909-7/1			
	REVISION	2	SHEET	1 of 1	